

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

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(Engineering Calculation)

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**TOTAL MASS (g) : 0.072708**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001510	1000000	20768.0449219		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000063	1000000	866.481323242		
Lead Frame	A42	Copper (Cu)	7440-50-8	0.000000	0	0		
		Iron (Fe)	7439-89-6	0.014071	580000	193527.921875		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.010189	420000	140136.171875		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.024260</b>	<b>1000000</b>	<b>333664.09375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20312.1386719		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20312.1386719</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000194	1000000	2668.21240234		
<b>Internal Plating Total:</b>				<b>0.000194</b>	<b>1000000</b>	<b>2668.21240234</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000571	750000	7853.34667969		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000190	250000	2613.19775391		
<b>Die Attach Total:</b>				<b>0.000761</b>	<b>1000000</b>	<b>10466.5439453</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006639	150000	91310.625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.036292	820000	499148.3125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001106	25000	15211.5615234		
		Carbon Black (C)	1333-86-4	0.000221	5000	3039.56152344		
		<b>Encapsulation Total:</b>				<b>0.044258</b>	<b>1000000</b>	<b>608710</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000185	1000000	2544.42944336		
					<b>TOTAL MASS (g) :</b>	<b>0.072708</b>		